

# XP131A1715SR

 TOREX

## **Power MOS FET**

- ◆ N-Channel Power MOS FET
  - ◆ DMOS Structure
  - ◆ Low On-State Resistance :  $0.012\ \Omega$  (max)
  - ◆ Ultra High-Speed Switching
  - ◆ SOP-8 Package

## ■ General Description

The XP131A1715SR is an N-Channel Power MOS FET with low on-state resistance and ultra high-speed switching characteristics. Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. The small SOP-8 package makes high density mounting possible.

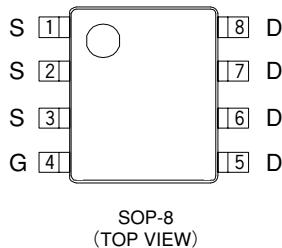
## ■ Applications

- Notebook PCs
  - Cellular and portable phones
  - On-board power supplies
  - Li-ion battery systems

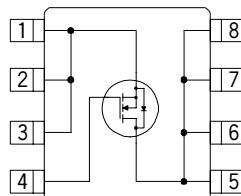
## ■ Features

- Low on-state resistance** :  $R_{ds(on)} = 0.012\Omega$  ( $V_{gs} = 4.5V$ )  
 :  $R_{ds(on)} = 0.015\Omega$  ( $V_{gs} = 2.5V$ )  
 :  $R_{ds(on)} = 0.025\Omega$  ( $V_{gs} = 1.5V$ )
- Ultra high-speed switching**
- Operational Voltage** : 1.5V
- High density mounting** : SOP-8

## ■ Pin Configuration



## ■ Equivalent Circuit



N-Channel MOS FET  
( 1 device built-in )

## ■ Pin Assignment

PIN NUMBER	PIN NAME	FUNCTION
1 ~ 3	S	Source
4	G	Gate
5 ~ 8	D	Drain

## Absolute Maximum Ratings

Ta=25°C			
PARAMETER	SYMBOL	RATINGS	UNITS
Drain - Source Voltage	Vdss	20	V
Gate - Source Voltage	Vgss	± 8	V
Drain Current (DC)	Id	10	A
Drain Current (Pulse)	Idp	40	A
Reverse Drain Current	ldr	10	A
Continuous Channel Power Dissipation (note)	Pd	2.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 ~ 150	°C

( note ) : When implemented on a glass epoxy PCB

## ■ Electrical Characteristics

### DC Characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Drain Cut-off Current	Idss	Vds = 20V , Vgs = 0V			10	µA
Gate-Source Leakage Current	Igss	Vgs = ± 8V , Vds = 0V			± 1	µA
Gate-Source Cut-off Voltage	Vgs ( off )	Id = 1mA , Vds = 10V	0.5		1.2	V
Drain-Source On-state Resistance ( note )	Rds ( on )	Id = 5A , Vgs = 4.5V		0.009	0.012	Ω
		Id = 5A , Vgs = 2.5V		0.011	0.015	Ω
		Id = 5A , Vgs = 1.5V		0.017	0.025	Ω
Forward Transfer Admittance ( note )	Yfs	Id = 5A , Vds = 10V		34		S
Body Drain Diode Forward Voltage	Vf	If = 10A , Vgs = 0V		0.8	1.1	V

( note ) : Effective during pulse test.

### Dynamic Characteristics

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input Capacitance	Ciss	Vds = 10V , Vgs = 0V f = 1 MHz		2000		pF
Output Capacitance	Coss			1000		pF
Feedback Capacitance	Crss			450		pF

### Switching Characteristics

Ta=25°C

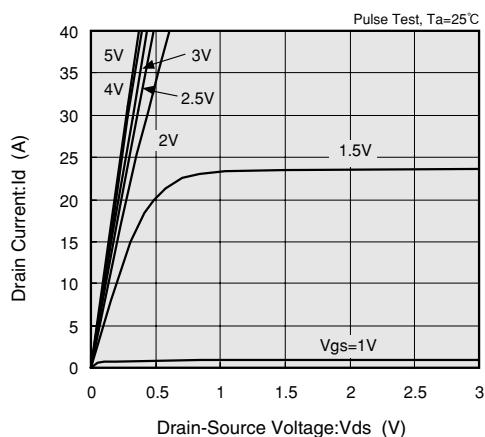
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Turn-on Delay Time	td ( on )	Vgs = 5V , Id = 5A Vdd = 10V		15		ns
Rise Time	tr			25		ns
Turn-off Delay Time	td ( off )			95		ns
Fall Time	tf			15		ns

### Thermal Characteristics

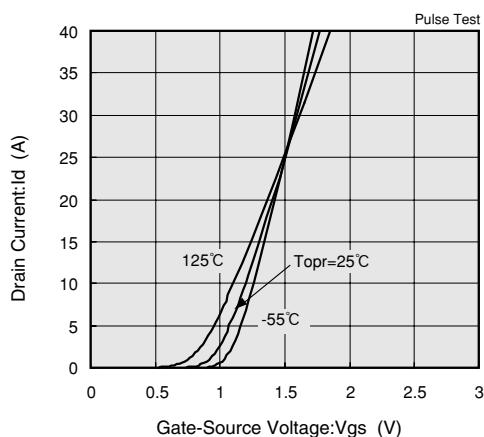
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Thermal Resistance ( channel-ambience )	Rth ( ch-a )	Implement on a glass epoxy resin PCB		50		°C / W

## ■ Typical Performance Characteristics

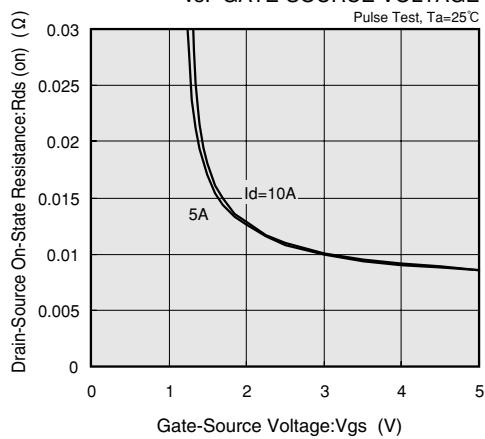
DRAIN CURRENT vs. DRAIN-SOURCE VOLTAGE



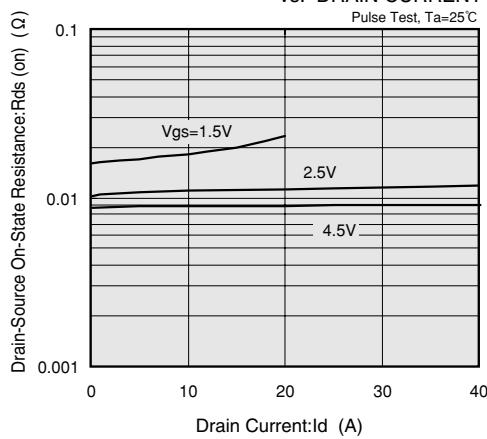
DRAIN CURRENT vs. GATE-SOURCE VOLTAGE



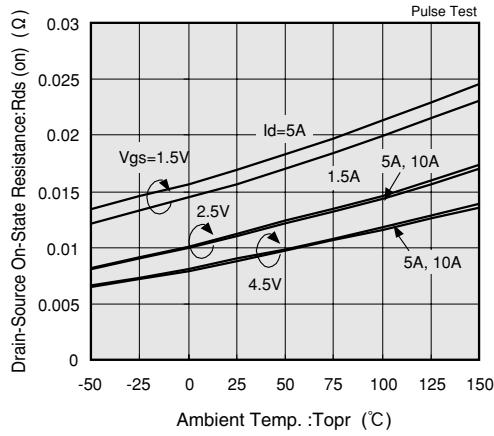
DRAIN-SOURCE ON-STATE RESISTANCE vs. GATE-SOURCE VOLTAGE



DRAIN-SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



DRAIN-SOURCE ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



GATE-SOURCE CUT-OFF VOLTAGE VARIANCE vs. AMBIENT TEMPERATURE

